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10/517,616

LIST OF REFERENCES CITED BY APPLICANT

APPLICANT

Gabriel NAVARRO NIEDERCORN

FILING DATE
September 27, 2005GROUP
3754

U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
/PB/	AA	5,783,268	07-21-1998	Noonan et al.	428	34.5	
	AB	5,750,225	05-12-1998	Petty	428	36.2	
	AC	5,040,297	08-20-1991	Scheinost	30	487	
	AD	4,400,678	01-15-1990	Marquette et al.			
/PB/	AE	4,179,808	12-25-1979	Smith	30	293	
	AL	4,064,627	12-27-1977	Zanfini	30	287	
	AC	4,064,626	12-27-1977	Meshulam et al.	30	287	
	AH	3,092,529	06-04-1963	A. J. Pearson	138	149	
	AI	2001/0003993	06-21-2001	Faverio, IV et al.	138	149	
	AL						
	AK						
	AL						
	AM						
	AN						

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	TRANSLATION	
					YES	NO
/PB/	AO	DE 1 190 391	04-01-1965	Germany	X	
	AP	FR 2 409 855	06-22-1979	France (English Abstract)		X
	AQ	FR 2 740 804	05-09-1997	France (English Abstract)		X
	AR	GB 2 189 273	10-21-1987	Great Britain		
	AS					
	AT					
	AU					
	AV					

OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)

/PB/	AW	NAIMA (North American Insulation Manufacturers Association); Fibrous Glass Duct Construction Standards, 5 th Edition, Low Velocity Systems 2 Inches (500Pa) Maximum Static Pressure, 2002; pgs. 133				
	AX	Johns Manville, Air Handling Systems Micro-Aire Duct Board, 2 pgs.				
	AY	Notice of Opposition to a European Patent; EP1532391; granted March 18, 2009; Insulation Panel for Supply Duct; 7 pgs.				
	AZ	Opposition against European patent EP1532391 B1; Opponent: Knauf Insulation Technology; Arguments in Support of Opposition; 9 pgs.				<input type="checkbox"/> Additional References sheet(s) attached

Examiner /Patrick Brinson/

Date Considered 07/13/2010

*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.